Low-Voltage CMOS Octal Transceiver

With 5 V–Tolerant Inputs and Outputs (3–State, Non–Inverting)

The 74LVC245A is a high performance, non-inverting octal transceiver operating from a 1.2 to 3.6 V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A V_I specification of 5.5 V allows 74LVC245A inputs to be safely driven from 5 V devices if V_{CC} is less than 5.0 V. The 74LVC245A is suitable for memory address driving and all TTL level bus oriented transceiver applications.

Current drive capability is 24 mA at both A and B ports. The Transmit/Receive (T/\overline{R}) input determines the direction of data flow through the bi-directional transceiver. Transmit (active-HIGH) enables data from A ports to B ports; Receive (active-LOW) enables data from B to A ports. The Output Enable input, when HIGH, disables both A and B ports by placing them in a HIGH Z condition.

Features

- Designed for 1.2 to 3.6 V V_{CC} Operation
- 5 V Tolerant Interface Capability with 5 V TTL Logic
- Supports Live Insertion and Withdrawal
- I_{OFF} Specification Guarantees High Impedance When $V_{CC} = 0 V$
- 24 mA Output Sink and Source Capability
- Near Zero Static Supply Current in All Three Logic States (10 μA) Substantially Reduces System Power Requirements
- ESD Performance: Human Body Model >2000 V Machine Model >200 V
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



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(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.



Figure 1. Pinout (Top View)

PIN NAMES

| PINS | FUNCTION |
|-------|--|
| ŌE | Output Enable Input |
| T/R | Transmit/Receive Input |
| A0-A7 | Side A 3–State Inputs or 3–State Outputs |
| B0-B7 | Side B 3–State Inputs or 3–State Outputs |
| | |

TRUTH TABLE

| INF | PUTS | OPERATING MODE |
|-----|------|-----------------|
| ŌĒ | T/R | Non-Inverting |
| L | L | B Data to A Bus |
| L | Н | A Data to B Bus |
| н | Х | Z |

H = High Voltage Level

L = Low Voltage Level Z = High Impedance State

X = High or Low Voltage Level and Transitions are Acceptable For I_{CC} reasons, Do Not Float Inputs



Figure 2. Logic Diagram

MAXIMUM RATINGS

| Symbol | Parameter | Condition | Value | Unit |
|------------------|---|--------------------------------------|-----------------------------------|------|
| V _{CC} | DC Supply Voltage | | -0.5 to +6.5 | V |
| VI | DC Input Voltage | | $-0.5 \leq V_{l} \leq +6.5$ | V |
| V _O | DC Output Voltage | Output in 3–State | $-0.5 \leq V_O \leq +6.5$ | V |
| | | Output in HIGH or LOW State (Note 1) | $-0.5 \leq V_O \leq V_{CC} + 0.5$ | |
| I _{IK} | DC Input Diode Current | V _I < GND | -50 | mA |
| I _{OK} | DC Output Diode Current | V _O < GND | -50 | mA |
| | | V _O > V _{CC} | +50 | mA |
| Ι _Ο | DC Output Source/Sink Current | | ±50 | mA |
| I _{CC} | DC Supply Current Per Supply Pin | | ±100 | mA |
| I _{GND} | DC Ground Current Per Ground Pin | | ±100 | mA |
| T _{STG} | Storage Temperature Range | | -65 to +150 | °C |
| ΤL | Lead Temperature, 1 mm from Case for 10 Seconds | | T _L = 260 | °C |
| TJ | Junction Temperature Under Bias | | T _J = 135 | °C |
| θ_{JA} | Thermal Resistance (Note 2) | | 110.7 | °C/W |
| MSL | Moisture Sensitivity | Level 1 | | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. I_O absolute maximum rating must be observed.

2. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow.

RECOMMENDED OPERATING CONDITIONS

| Symbol | l Parameter | | | Тур | Max | Unit |
|-----------------|------------------------------------|--|-------------|-----|------------------------|------|
| V _{CC} | Supply Voltage | Operating Functional | 1.65 1.2 | | 3.6 3.6 | V |
| VI | Input Voltage | | 0 | | 5.5 | V |
| Vo | Output Voltage | HIGH or LOW State 3–State | 0 0 | | V _{CC} 5.5 | V |
| I _{OH} | HIGH Level Output Current | $V_{CC} = 3.0 V - 3.6 V$ $V_{CC} = 2.7 V - 3.0 V$ | | | -24 -12 | mA |
| I _{OL} | LOW Level Output Current | $V_{CC} = 3.0 V - 3.6 V$ $V_{CC} = 2.7 V - 3.0 V$ | | | 24 12 | mA |
| T _A | Operating Free–Air Temperature | | -40 | | +125 | °C |
| Δt/ΔV | Input Transition Rise or Fall Rate | $V_{CC} = 1.2 \text{ to } 2.7 \text{ V}$ $V_{CC} = 2.7 \text{ to } 3.6 \text{ V}$ | 0 0 | | 20 10 | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

| | | | –40 to +85°C | | –40 to +125°C | | | | |
|------------------|---------------------------|--|---------------------------|-----------------|---------------------------|---------------------------|-----------------|---------------------------|------|
| Symbol | Parameter | Conditions | Min | Typ (Note 3) | Max | Min | Typ (Note 3) | Max | Unit |
| V _{IH} | HIGH-level input voltage | V _{CC} = 1.2 V | 1.08 | - | - | 1.08 | - | - | V |
| | | V _{CC} = 1.65 V to 1.95 V | 0.65 x V _{CC} | - | - | 0.65 x V _{CC} | - | - | |
| | | V_{CC} = 2.3 V to 2.7 V | 1.7 | - | - | 1.7 | _ | - | |
| | | V _{CC} = 2.7 V to 3.6 V | 2.0 | - | - | 2.0 | - | - | |
| V _{IL} | LOW-level input voltage | V _{CC} = 1.2 V | - | - | 0.12 | - | - | 0.12 | V |
| | | V _{CC} = 1.65 V to 1.95 V | - | - | 0.35 x V _{CC} | - | - | 0.35 x V _{CC} | |
| | | V_{CC} = 2.3 V to 2.7 V | - | - | 0.7 | - | - | 0.7 | |
| | | V_{CC} = 2.7 V to 3.6 V | - | - | 0.8 | - | - | 0.8 | |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or | VIL | | | - | - | I | V |
| | | $I_{O} = -100 \ \mu\text{A};$ $V_{CC} = 1.65 \ \text{V} \text{ to } 3.6 \ \text{V}$ | V _{CC} - 0.2 | - | - | V _{CC} - 0.3 | - | I | |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.2 | _ | - | 1.05 | - | 1 | |
| | | $I_{O} = -8$ mA; $V_{CC} = 2.3$ V | 1.8 | _ | - | 1.65 | - | - | |
| | | I_{O} = -12 mA; V_{CC} = 2.7 V | 2.2 | _ | - | 2.05 | - | - | |
| | | $I_{O} = -18$ mA; $V_{CC} = 3.0$ V | 2.4 | _ | - | 2.25 | - | Ι | |
| | | $I_{O} = -24$ mA; $V_{CC} = 3.0$ V | 2.2 | _ | - | 2.0 | - | Ι | |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or | VIL | - | - | - | - | - | V |
| | | $I_{O} = 100 \ \mu A;$ V _{CC} = 1.65 V to 3.6 V | - | - | 0.2 | - | - | 0.3 | |
| | | I_{O} = 4 mA; V_{CC} = 1.65 V | - | _ | 0.45 | - | - | 0.65 | |
| | | I_{O} = 8 mA; V_{CC} = 2.3 V | - | _ | 0.6 | - | - | 0.8 | |
| | | I_{O} = 12 mA; V_{CC} = 2.7 V | - | - | 0.4 | - | - | 0.6 | |
| | | I_{O} = 24 mA; V_{CC} = 3.0 V | - | - | 0.55 | - | - | 0.8 | |
| II. | Input leakage current | V _I = 5.5 V or GND V _{CC} = 3.6 V | - | ±0.1 | ±5 | - | ±0.1 | ±20 | μΑ |
| I _{OZ} | OFF-state output current | $V_{I} = V_{IH} \text{ or } V_{IL}; V_{O} = 5.5 \text{ V or}$ GND; $V_{CC} = 3.6 \text{ V}$ | - | ±0.1 | ±5 | - | ±0.1 | ±20 | μΑ |
| I _{OFF} | Power-off leakage current | V_{I} or V_{O} = 5.5 V; V_{CC} = 0 V | - | ±0.1 | ±10 | - | ±0.1 | ±20 | μΑ |
| Icc | Supply current | $V_{I} = V_{CC}$ or GND; $I_{O} = 0$ A; $V_{CC} = 3.6$ V | - | 0.1 | 10 | _ | 0.1 | 40 | μΑ |
| Icc | Additional supply current | per input pin; $V_I = V_{CC} - 0.6 V$; $I_O = 0 A$; $V_{CC} = 2.7 V$ to 3.6 V | - | 5 | 500 | - | 5 | 5000 | μΑ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. All typical values are measured at $T_A = 25^{\circ}C$ and $V_{CC} = 3.3$ V, unless stated otherwise.

AC ELECTRICAL CHARACTERISTICS ($t_R = t_F = 2.5 \text{ ns}$)

| | | | –40 to +85°C | | _4 | | | | |
|--------------------|----------------------------|------------------------------------|--------------|-----------------|------|-----|------------------------|------|------|
| Symbol | Parameter | Conditions | Min | Typ (Note 4) | Max | Min | Typ (Note 4) | Max | Unit |
| t _{pd} | Propagation Delay (Note 5) | V _{CC} = 1.2 V | - | 17.0 | - | - | - | - | ns |
| | An to Bn, Bn to An | V _{CC} = 1.65 V to 1.95 V | 1.5 | 6.5 | 14.6 | 1.0 | - | 16.9 | |
| | | V_{CC} = 2.3 V to 2.7 V | 1.0 | 3.4 | 7.6 | 1.0 | - | 8.7 | |
| | | V _{CC} = 2.7 V | 1.0 | 3.4 | 7.3 | 1.0 | - | 9.5 | |
| | | V_{CC} = 3.0 V to 3.6 V | 1.0 | 2.9 | 6.3 | 1.0 | - | 8.0 | |
| t _{en} | Enable Time (Note 6) | V _{CC} = 1.2 V | - | 22.0 | - | _ | - | - | ns |
| | OE to An, Bn | V_{CC} = 1.65 V to 1.95 V | 1.0 | 8.3 | 19.5 | 1.0 | - | 22.5 | |
| | | V_{CC} = 2.3 V to 2.7 V | 1.0 | 4.6 | 10.7 | 1.0 | - | 12.4 | |
| | | V _{CC} = 2.7 V | 1.0 | 4.8 | 9.5 | 0.5 | - | 12.0 | |
| | | V_{CC} = 3.0 V to 3.6 V | 0.5 | 3.7 | 8.5 | 0.5 | - | 11.0 | |
| t _{dis} | Disable Time (Note 7) | V _{CC} = 1.2 V | - | 12.0 | - | - | - | - | ns |
| | OE to An, Bn | V_{CC} = 1.65 V to 1.95 V | 1.0 | 5.5 | 12.3 | 1.0 | - | 14.2 | |
| | | V_{CC} = 2.3 V to 2.7 V | 1.0 | 3.1 | 7.1 | 1.0 | - | 8.2 | |
| | | V _{CC} = 2.7 V | 1.0 | 3.9 | 8.0 | 0.5 | - | 10.0 | |
| | | V_{CC} = 3.0 V to 3.6 V | 0.5 | 3.6 | 7.0 | 0.5 | - | 9.0 | |
| t _{sk(0)} | Output Skew Time (Note 8) | | - | - | 1.0 | _ | - | 1.5 | ns |

4. Typical values are measured at T_A = 25°C and V_{CC} = 3.3 V, unless stated otherwise.
5. t_{pd} is the same as t_{PLH} and t_{PHL}.
6. t_{en} is the same as t_{PLZ} and t_{PLZ}.
7. t_{dis} is the same as t_{PLZ} and t_{PHZ}.
8. Skew between any two outputs of the same package switching in the same direction.

8. Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

DYNAMIC SWITCHING CHARACTERISTICS

| | | | T _A = +25°C | | | |
|------------------|-------------------------------------|---|------------------------|--------------|-----|--------|
| Symbol | Characteristic | Condition | Min | Тур | Max | Unit |
| V _{OLP} | Dynamic LOW Peak Voltage (Note 9) | $ \begin{array}{l} {\sf V}_{CC} = 3.3 \; {\sf V}, \; {\sf C}_L = 50 \; {\sf pF}, \; {\sf V}_{IH} = 3.3 \; {\sf V}, \; {\sf V}_{IL} = 0 \; {\sf V} \\ {\sf V}_{CC} = 2.5 \; {\sf V}, \; {\sf C}_L = 30 \; {\sf pF}, \; {\sf V}_{IH} = 2.5 \; {\sf V}, \; {\sf V}_{IL} = 0 \; {\sf V} \end{array} $ | | 0.8 0.6 | | V V |
| V _{OLV} | Dynamic LOW Valley Voltage (Note 9) | $ \begin{array}{l} {\sf V}_{CC} = 3.3 \; {\sf V}, \; {\sf C}_L = 50 \; {\sf pF}, \; {\sf V}_{IH} = 3.3 \; {\sf V}, \; {\sf V}_{IL} = 0 \; {\sf V} \\ {\sf V}_{CC} = 2.5 \; {\sf V}, \; {\sf C}_L = 30 \; {\sf pF}, \; {\sf V}_{IH} = 2.5 \; {\sf V}, \; {\sf V}_{IL} = 0 \; {\sf V} \end{array} $ | | -0.8 -0.6 | | V V |

9. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

CAPACITIVE CHARACTERISTICS

| Symbol | Parameter | Condition | Typical | Unit |
|------------------|-------------------------------|---|---------|------|
| C _{IN} | Input Capacitance (OE, T/R) | V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC} | 4.0 | pF |
| C _{I/O} | Input/Output Capacitance | V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC} | 10.0 | pF |
| C _{PD} | Power Dissipation Capacitance | Per input; $V_I = GND$ or V_{CC} | | |
| | (Note 10) | V _{CC} = 1.65 V to 1.95 V | 7.7 | |
| | | V_{CC} = 2.3 V to 2.7 V | 11.3 | |
| | | V_{CC} = 3.0 V to 3.6 V | 14.4 | |

10. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times fi \times N + \Sigma (C_L \times V_{CC}^2 \times fo)$ where: fi = input frequency in MHz; fo = output frequency in MHz C_L = output load capacitance in pF

 V_{CC} = supply voltage in Volts N = number of outputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of the outputs.}$

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WAVEFORM 1 – PROPAGATION DELAYS $t_{R} = t_{F} = 2.5 \text{ ns}, 10\% \text{ to } 90\%; f = 1 \text{ MHz}; t_{W} = 500 \text{ ns}$

WAVEFORM 2 – OUTPUT ENABLE AND DISABLE TIMES t_R = t_F = 2.5 ns, 10% to 90%; f = 1 MHz; t_W = 500 ns

| | V _{CC} | | | | | | | |
|-----------------|--------------------------|--------------------------|--------------------------|-------------------------|-------------------------|--|--|--|
| Symbol | 1.2 V | 1.8 V ± 0.15 V | 2.5 V ± 0.2 V | 2.7 V | 3.3 V ± 0.3 V | | | |
| VI | V _{CC} | V _{CC} | V _{CC} | 2.7 V | 2.7 V | | | |
| Vmi | V _{CC} /2 | V _{CC} /2 | V _{CC} /2 | 1.5 V | 1.5 V | | | |
| Vmo | V _{CC} /2 | V _{CC} /2 | V _{CC} /2 | 1.5 V | 1.5 V | | | |
| V _{HZ} | V _{OL} + 0.15 V | V _{OL} + 0.15 V | V _{OL} + 0.15 V | V _{OL} + 0.3 V | V _{OL} + 0.3 V | | | |
| V _{LZ} | V _{OH} – 0.15 V | V _{OH} – 0.15 V | V _{OH} – 0.15 V | V _{OH} – 0.3 V | V _{OH} – 0.3 V | | | |

Figure 3. AC Waveforms



 C_L includes jig and probe capacitance R_T = Z_{OUT} of pulse generator (typically 50 Q) R_1 = R_L

| Supply Voltage | Inp | out | Lo | ad | | V _{EXT} | |
|---------------------|-----------------|---------------------------------|-------|-------|-------------------------------------|-------------------------------------|-------------------------------------|
| V _{CC} (V) | VI | t _r , t _f | CL | RL | t _{PLH} , t _{PHL} | t _{PLZ} , t _{PZL} | t _{PHZ} , t _{PZH} |
| 1.2 | V _{CC} | ≤ 2 ns | 30 pF | 1 kQ | Open | 2 x V _{CC} | GND |
| 1.65 – 1.95 | V _{CC} | ≤ 2 ns | 30 pF | 1 kQ | Open | 2 x V _{CC} | GND |
| 2.3 – 2.7 | V _{CC} | ≤ 2 ns | 30 pF | 500 Q | Open | 2 x V _{CC} | GND |
| 2.7 | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Q | Open | 2 x V _{CC} | GND |
| 3.0 - 3.6 | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Q | Open | 2 x V _{CC} | GND |

Figure 4. Test Circuit

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|----------------|-----------------------|-----------------------|
| 74LVC245ADTR2G | TSSOP–20 (Pb–Free) | 2500 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS





 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL

| | MILLIMETERS | | INC | HES | |
|-----|-------------|------|-----------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 6.40 | 6.60 | 0.252 | 0.260 | |
| В | 4.30 | 4.50 | 0.169 | 0.177 | |
| C | | 1.20 | | 0.047 | |
| D | 0.05 | 0.15 | 0.002 | 0.006 | |
| F | 0.50 | 0.75 | 0.020 | 0.030 | |
| G | 0.65 | BSC | 0.026 BSC | | |
| Н | 0.27 | 0.37 | 0.011 | 0.015 | |
| J | 0.09 | 0.20 | 0.004 | 0.008 | |
| J1 | 0.09 | 0.16 | 0.004 | 0.006 | |
| K | 0.19 | 0.30 | 0.007 | 0.012 | |
| K1 | 0.19 | 0.25 | 0.007 | 0.010 | |
| L | 6.40 | BSC | 0.252 | BSC | |
| M | 0° | 8° | 0° | 8° | |
| | | | | | |

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